Hex Inverter with Enable

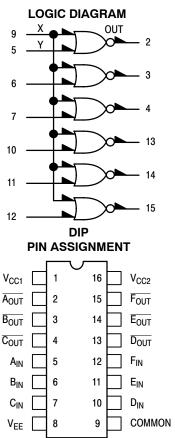
Description

The MC10H189 is a Hex Inverter with a common Enable input. The hex inverting function is provided when Enable is in the low-state. When Enable is in the high-state, all outputs are low.

This MECL 10HTM part is a functional/pinout duplication of the standard MECL 10KTM family part, with 100% improvement in propagation delay and no increase in power-supply current.

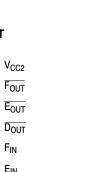
Features

- Propagation Delay, 1.3 ns Typical Data-to-Output
- Power Dissipation 180 mW Typ/Pkg (No Load)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K Compatible
- Pb–Free Packages are Available*

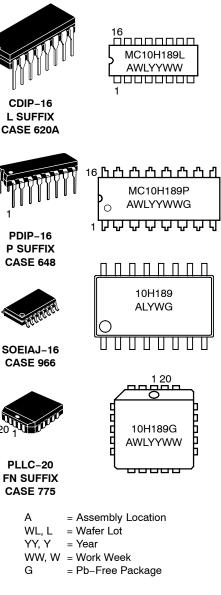


TRUTH TABLE						
Inputs Output						
Х	Υ	OUT				
L	L	Н				
L	Н	L				
Н	L	L				
Н	Н	L				

 $V_{CC1} = Pin 1$ $V_{CC2} = Pin 16$ $V_{EE} = Pin 8$







*For additional marking information, refer to Application Note AND8002/D.

ORDERING INFORMATION

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 18

of the ON Semiconductor MECL Data Book (DL122/D).

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

Table 1. MAXIMUM RATINGS

Symbol	Characteristic	Rating	Unit
V_{EE}	Power Supply (V _{CC} = 0)	-8.0 to 0	Vdc
VI	Input Voltage (V _{CC} = 0)	0 to V _{EE}	Vdc
l _{out}	Output Current – Continuous – Surge	50 100	mA
T _A	Operating Temperature Range	0 to +75	°C
T _{stg}	Storage Temperature Range – Plastic – Ceramic	-55 to +150 -55 to +165	°C ℃

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

Table 2. ELECTRICAL CHARACTERISTICS ($V_{EE} = -5.2 \text{ V} \pm 5\%$) (Note 1)

		0 °		25°		75 °		
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
١ _E	Power Supply Current	-	46	-	42	-	46	mA
I _{inH}	Input Current High	-	495	-	310	-	310	μΑ
I _{inL}	Input Current Low	0.5	-	0.5	-	0.3	-	μΑ
V _{OH}	High Output Voltage	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
V _{OL}	Low Output Voltage	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
V _{IH}	High Input Voltage	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
VIL	Low Input Voltage	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

 Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50 Ω resistor to -2.0 V.

Table 3. AC PARAMETERS

		0 °		25 °		75 °		
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
t _{pd}	Propagation Delay Enable Data	0.7 0.7	2.2 1.9	0.7 0.7	2.2 1.9	0.7 0.7	2.3 1.9	ns
t _r	Rise Time	0.7	2.4	0.7	2.4	0.7	2.4	ns
t _f	Fall Time	0.7	2.4	0.7	2.4	0.7	2.4	ns

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

ORDERING INFORMATION

Device	Package	Shipping [†]
MC10H189FN	PLLC-20	46 Units / Rail
MC10H189FNG	PLLC-20 (Pb-Free)	46 Units / Rail
MC10H189FNR2	PLLC-20	500 / Tape & Reel
MC10H189FNR2G	PLLC-20 (Pb-Free)	500 / Tape & Reel
MC10H189L	CDIP-16	25 Unit / Rail
MC10H189M	SOEIAJ-16	50 Unit / Rail
MC10H189MG	SOEIAJ-16 (Pb-Free)	50 Unit / Rail
MC10H189MEL	SOEIAJ-16	2000 / Tape & Reel
MC10H189MELG	SOEIAJ-16 (Pb-Free)	2000 / Tape & Reel
MC10H189P	PDIP-16	25 Unit / Rail
MC10H189PG	PDIP-16 (Pb-Free)	25 Unit / Rail

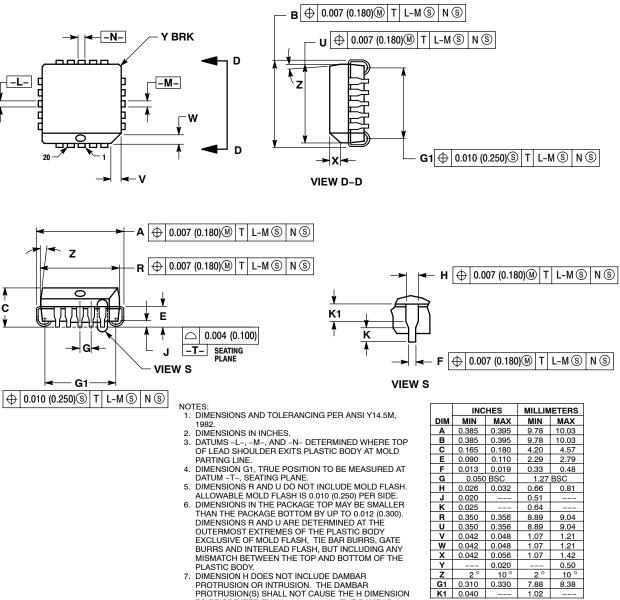
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MC10H189

PACKAGE DIMENSIONS



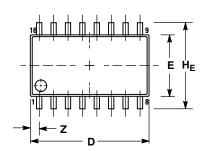
CASE 775-02 ISSUE E

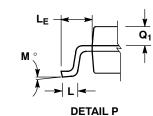


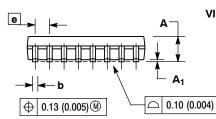
PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

PACKAGE DIMENSIONS

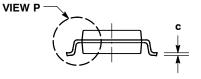
SOEIAJ-16 CASE 966-01 **ISSUE A**







Ν



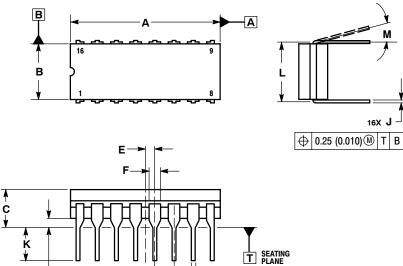
- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
 5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018). TO BE 0.46 (0.018).

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α		2.05		0.081
A ₁	0.05	0.20	0.002	0.008
q	0.35	0.50	0.014	0.020
C	0.10	0.20	0.007	0.011
D	9.90	10.50	0.390	0.413
Е	5.10	5.45	0.201	0.215
e	1.27	BSC	0.050 BSC	
HE	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
LE	1.10	1.50	0.043	0.059
Μ	0 °	10 °	0 °	10 °
Q1	0.70	0.90	0.028	0.035
Ζ		0.78		0.031

CDIP-16 L SUFFIX CERAMIC DIP PACKAGE CASE 620A-01 **ISSUE O**

16X J



G

– 16X D

⊕ 0.25 (0.010) M T A

NOTES:

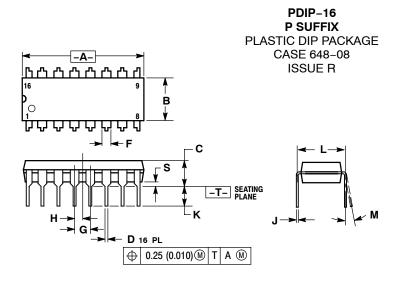
NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL. 4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC PODY

BODY. THIS DRAWING REPLACES OBSOLETE CASE OUTLINE 620-10. 5

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С		0.200		5.08	
D	0.015	0.020	0.39	0.50	
Е	0.050	BSC	1.27 BSC		
F	0.055	0.055 0.065		1.65	
G	0.100	BSC	2.54 BSC		
Н	0.008	0.015	0.21	0.38	
K	0.125	0.170	3.18	4.31	
L	0.300 BSC		7.62 BSC		
М	0 °	15 °	0 °	15°	
Ν	0.020	0.040	0.51	1.01	

MC10H189

PACKAGE DIMENSIONS



NOTES:

DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982.

CONTROLLING DIMENSION: INCH.

DIMENSION L TO CENTER OF LEADS WHEN 3

FORMED PARALLEL DIMENSION B DOES NOT INCLUDE MOLD FLASH. ROUNDED CORNERS OPTIONAL. 5.

	INC	HES	MILLIM	ETERS	
DIM	MIN MAX		MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
Μ	0 °	10 °	0 °	10 °	
S	0.020	0.040	0.51	1.01	

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